

# Zhenyu Zhang

## List of Publications by Year in descending order

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73  
papers

3,590  
citations

136950

32  
h-index

133252

59  
g-index

73  
all docs

73  
docs citations

73  
times ranked

2281  
citing authors

#	ARTICLE	IF	CITATIONS
1	Enhanced tribological properties of aligned graphene-epoxy composites. <i>Friction</i> , 2022, 10, 854-865.	6.4	18
2	Investigation on wear characteristics of cemented carbide tools in finish turning spherical shells of pure iron. <i>International Journal of Advanced Manufacturing Technology</i> , 2022, 119, 4951-4961.	3.0	2
3	Zinc Methionine Improves the Growth Performance of Meat Ducks by Enhancing the Antioxidant Capacity and Intestinal Barrier Function. <i>Frontiers in Veterinary Science</i> , 2022, 9, 774160.	2.2	7
4	ATPR regulates human mantle cell lymphoma cells differentiation via SOX11/CyclinD1/Rb/E2F1. <i>Cellular Signalling</i> , 2022, 93, 110280.	3.6	2
5	Quantitatively investigating the self-attraction of nanowires. <i>Nano Research</i> , 2022, 15, 3729-3736.	10.4	3
6	Tracing the Active Phase and Dynamics for Carbon Nanofiber Growth on Nickel Catalyst Using Environmental Transmission Electron Microscopy. <i>Small Methods</i> , 2022, 6, e2200235.	8.6	12
7	Experimental and Theoretical Investigations on Diamond Wire Sawing for a NdFeB Magnet. <i>Materials</i> , 2022, 15, 3034.	2.9	3
8	Excellent tribological properties of epoxy-Ti <sub>3</sub> C <sub>2</sub> with three-dimensional nanosheets composites. <i>Friction</i> , 2021, 9, 734-746.	6.4	36
9	Unprecedented enhancement of wear resistance for epoxy-resin graphene composites. <i>Nanoscale</i> , 2021, 13, 2855-2867.	5.6	34
10	Dynamics of the charging-induced imaging instability in transmission electron microscopy. <i>Nanoscale Advances</i> , 2021, 3, 3035-3040.	4.6	5
11	An <i>in situ</i> TEM nanoindentation-induced new nanostructure in cadmium zinc telluride. <i>Nanoscale</i> , 2021, 13, 7169-7175.	5.6	1
12	Editorial: special issue "ultraprecision 2019". <i>Applied Nanoscience (Switzerland)</i> , 2021, 11, 735-735.	3.1	0
13	Chemical mechanical polishing for sapphire wafers using a developed slurry. <i>Journal of Manufacturing Processes</i> , 2021, 62, 762-771.	5.9	89
14	Engineering Nanostructure-Interface of Photoanode Materials Toward Photoelectrochemical Water Oxidation. <i>Advanced Materials</i> , 2021, 33, e2005389.	21.0	100
15	Non-spherical abrasives with ordered mesoporous structures for chemical mechanical polishing. <i>Science China Materials</i> , 2021, 64, 2747-2763.	6.3	21
16	A review: green chemical mechanical polishing for metals and brittle wafers. <i>Journal Physics D: Applied Physics</i> , 2021, 54, 373001.	2.8	25
17	Design of composite abrasives and substrate materials for chemical mechanical polishing applications. <i>Applied Nanoscience (Switzerland)</i> , 2020, 10, 1379-1393.	3.1	14
18	Development of a novel chemical mechanical polishing slurry and its polishing mechanisms on a nickel alloy. <i>Applied Surface Science</i> , 2020, 506, 144670.	6.1	143

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19	A novel process of chemical mechanical polishing for FV520B steel. <i>Journal of Manufacturing Processes</i> , 2020, 59, 51-57.	5.9	20
20	Deformation-induced silicon nanostructures. <i>APL Materials</i> , 2020, 8, .	5.1	2
21	Green chemical mechanical polishing of sapphire wafers using a novel slurry. <i>Nanoscale</i> , 2020, 12, 22518-22526.	5.6	118
22	Effects of thickness on thermoelectric properties of Bi <sub>0.5</sub> Sb <sub>1.5</sub> Te <sub>3</sub> thin films. <i>Applied Nanoscience (Switzerland)</i> , 2020, 10, 2375-2381.	3.1	6
23	Self-healing on mismatched fractured composite surfaces of SiC with a diameter of 180 nm. <i>Nanoscale</i> , 2020, 12, 19617-19627.	5.6	3
24	Macroscale Superlubricity: Macroscale Superlubricity Enabled by Graphene-Coated Surfaces ( <i>Adv. Sci.</i> ) Tj ETQq0 0,0,rgBT /Qverlock 10	11.2	4
25	Macroscale Superlubricity Enabled by Graphene-Coated Surfaces. <i>Advanced Science</i> , 2020, 7, 1903239.	11.2	64
26	Research on different cooling methods in the machining of CGI and GCI. <i>Applied Nanoscience (Switzerland)</i> , 2020, 10, 2177-2188.	3.1	7
27	Highly flexible few-layer Ti <sub>3</sub> C <sub>2</sub> MXene/cellulose nanofiber heat-spreader films with enhanced thermal conductivity. <i>New Journal of Chemistry</i> , 2020, 44, 7186-7193.	2.8	38
28	Effect of Internal Air Flow on Local Postweld Heat Treatment for Large Diameter ASME P92 Steel-Welded Pipes. <i>Journal of Pressure Vessel Technology, Transactions of the ASME</i> , 2020, 142, .	0.6	0
29	Unprecedented Piezoresistance Coefficient in Strained Silicon Carbide. <i>Nano Letters</i> , 2019, 19, 6569-6576.	9.1	62
30	Enhanced Thermal Conductivity of Epoxy Composites Filled with 2D Transition Metal Carbides (MXenes) with Ultralow Loading. <i>Scientific Reports</i> , 2019, 9, 9135.	3.3	104
31	Ultrahigh Recovery of Fracture Strength on Mismatched Fractured Amorphous Surfaces of Silicon Carbide. <i>ACS Nano</i> , 2019, 13, 7483-7492.	14.6	54
32	Identification of COP9 Signalosome Subunit Genes in <i>Bactrocera dorsalis</i> and Functional Analysis of csn3 in Female Fecundity. <i>Frontiers in Physiology</i> , 2019, 10, 162.	2.8	7
33	Deformation induced new pathways in silicon. <i>Nanoscale</i> , 2019, 11, 9862-9868.	5.6	10
34	Deformation induced complete amorphization at nanoscale in a bulk silicon. <i>AIP Advances</i> , 2019, 9, .	1.3	5
35	Environment friendly chemical mechanical polishing of copper. <i>Applied Surface Science</i> , 2019, 467-468, 5-11.	6.1	214
36	<i>In situ</i> TEM observation of rebonding on fractured silicon carbide. <i>Nanoscale</i> , 2018, 10, 6261-6269.	5.6	37

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37	Enhanced thermal conductivity of epoxy composites filled with tetrapod-shaped ZnO. RSC Advances, 2018, 8, 12337-12343.	3.6	41
38	Direct formation of wafer-scale single-layer graphene films on the rough surface substrate by PECVD. Carbon, 2018, 129, 456-461.	10.3	60
39	A novel approach of chemical mechanical polishing for a titanium alloy using an environment-friendly slurry. Applied Surface Science, 2018, 427, 409-415.	6.1	197
40	New Deformation-Induced Nanostructure in Silicon. Nano Letters, 2018, 18, 4611-4617.	9.1	182
41	A novel approach of high-performance grinding using developed diamond wheels. International Journal of Advanced Manufacturing Technology, 2017, 91, 3315-3326.	3.0	70
42	Ultrahigh hardness on a face-centered cubic metal. Applied Surface Science, 2017, 416, 891-900.	6.1	39
43	Formation mechanism of fivefold deformation twins in a face-centered cubic alloy. Scientific Reports, 2017, 7, 45405.	3.3	12
44	In Situ TEM Study of Interaction between Dislocations and a Single Nanotwin under Nanoindentation. ACS Applied Materials & Interfaces, 2017, 9, 29451-29456.	8.0	30
45	A novel approach of mechanical chemical grinding. Journal of Alloys and Compounds, 2017, 726, 514-524.	5.5	150
46	Characterization of the complex involved in regulating V-ATPase activity of the vacuolar and endosomal membrane. Journal of Bioenergetics and Biomembranes, 2017, 49, 347-355.	2.3	3
47	Nanoscale Wear Layers on Silicon Wafers Induced by Mechanical Chemical Grinding. Tribology Letters, 2017, 65, 1.	2.6	47
48	Construction and optimization of <i>trans</i> - $\epsilon$ -C <sub>4</sub> -hydroxy $\alpha$ -L $\epsilon$ -proline production recombinant <i>E. coli</i> strain taking the glycerol as carbon source. Journal of Chemical Technology and Biotechnology, 2016, 91, 2389-2398.	3.2	12
49	A novel approach to fabricating a nanotwinned surface on a ternary nickel alloy. Materials and Design, 2016, 106, 313-320.	7.0	31
50	A novel approach of chemical mechanical polishing for cadmium zinc telluride wafers. Scientific Reports, 2016, 6, 26891.	3.3	89
51	A novel approach of chemical mechanical polishing using environment-friendly slurry for mercury cadmium telluride semiconductors. Scientific Reports, 2016, 6, 22466.	3.3	85
52	Nanoscale solely amorphous layer in silicon wafers induced by a newly developed diamond wheel. Scientific Reports, 2016, 6, 35269.	3.3	14
53	Waterborne polyurethane conjugated with novel diol chain-extender bearing cyclic phosphoramidate lateral group: synthesis, flammability and thermal degradation mechanism. RSC Advances, 2016, 6, 56610-56622.	3.6	20
54	A novel approach of high speed scratching on silicon wafers at nanoscale depths of cut. Scientific Reports, 2015, 5, 16395.	3.3	133

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55	Real-Time, Quantitative Lighting-up Detection of Telomerase in Urines of Bladder Cancer Patients by AIEgens. <i>Analytical Chemistry</i> , 2015, 87, 6822-6827.	6.5	119
56	Lab in a Tube: Sensitive Detection of MicroRNAs in Urine Samples from Bladder Cancer Patients Using a Single-Label DNA Probe with AIEgens. <i>ACS Applied Materials &amp; Interfaces</i> , 2015, 7, 16813-16818.	8.0	61
57	Accessory enzymes influence cellulase hydrolysis of the model substrate and the realistic lignocellulosic biomass. <i>Enzyme and Microbial Technology</i> , 2015, 79-80, 42-48.	3.2	118
58	The impact of glycerol organosolv pretreatment on the chemistry and enzymatic hydrolyzability of wheat straw. <i>Bioresource Technology</i> , 2015, 187, 354-361.	9.6	107
59	Changes in surface layer of silicon wafers from diamond scratching. <i>CIRP Annals - Manufacturing Technology</i> , 2015, 64, 349-352.	3.6	208
60	Quencher Group Induced High Specificity Detection of Telomerase in Clear and Bloody Urines by AIEgens. <i>Analytical Chemistry</i> , 2015, 87, 9487-9493.	6.5	70
61	Development of a minimal chemically defined medium for <i>Ketogulonicigenium vulgare</i> WSH001 based on its genome-scale metabolic model. <i>Journal of Biotechnology</i> , 2014, 169, 15-22.	3.8	20
62	A model for nanogrinding based on direct evidence of ground chips of silicon wafers. <i>Science China Technological Sciences</i> , 2013, 56, 2099-2108.	4.0	109
63	Characterization of Nanoscale Chips and a Novel Model for Face Nanogrinding on Soft-Brittle HgCdTe Films. <i>Tribology Letters</i> , 2013, 49, 203-215.	2.6	29
64	Ultrahigh hardness and synergistic mechanism of a nanotwinned structure of cadmium zinc telluride. <i>Scripta Materialia</i> , 2013, 68, 747-750.	5.2	18
65	Nanoscale Material Removal Mechanism of Soft-Brittle HgCdTe Single Crystals Under Nanogrinding by Ultrafine Diamond Grits. <i>Tribology Letters</i> , 2012, 46, 95-100.	2.6	45
66	Grinding of silicon wafers using an ultrafine diamond wheel of a hybrid bond material. <i>International Journal of Machine Tools and Manufacture</i> , 2011, 51, 18-24.	13.4	79
67	Material removal mechanism of precision grinding of soft-brittle CdZnTe wafers. <i>International Journal of Advanced Manufacturing Technology</i> , 2010, 46, 563-569.	3.0	17
68	Nanoscale machinability and subsurface damage machined by CMP of soft-brittle CdZnTe crystals. <i>International Journal of Advanced Manufacturing Technology</i> , 2010, 47, 1105-1112.	3.0	26
69	Subsurface crystal lattice deformation machined by ultraprecision grinding of soft-brittle CdZnTe crystals. <i>International Journal of Advanced Manufacturing Technology</i> , 2010, 47, 1065-1081.	3.0	20
70	New deformation mechanism of soft-brittle CdZnTe single crystals under nanogrinding. <i>Scripta Materialia</i> , 2010, 63, 621-624.	5.2	22
71	Nanocutting Process of CdZnTe Single Crystals. <i>Materials and Manufacturing Processes</i> , 2009, 24, 504-508.	4.7	2
72	Chemical mechanical polishing and nanomechanics of semiconductor CdZnTe single crystals. <i>Semiconductor Science and Technology</i> , 2008, 23, 105023.	2.0	32

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73	Unusual stress behaviour of La <sub>2</sub> O <sub>3</sub> - and CeO <sub>2</sub> -doped diamond-like carbon nanofilms. Philosophical Magazine Letters, 2008, 88, 567-574.	1.2	3